# VS-HFA135NH40PbF

Vishay Semiconductors

# HEXFRED<sup>®</sup> Ultrafast Soft Recovery Diode, 275 A



www.vishay.com

PRIMARY CHARACTERISTICS				
I <sub>F</sub> (maximum)	275 A			
V <sub>R</sub>	400 V			
I <sub>F(DC)</sub> at T <sub>C</sub>	138 A at 100 °C			
Package	HALF-PAK (D-67)			
Circuit configuration	Single diode			

## FEATURES

## • Very low Q<sub>rr</sub> and t<sub>rr</sub>

- Designed and qualified for industrial level
- UL approved file E222165



 Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### BENEFITS

- Reduced RFI and EMI
- Reduced snubbing

### DESCRIPTION

HEXFRED<sup>®</sup> diodes are optimized to reduce losses and EMI/RFI in high frequency power conditioning systems. An extensive characterization of the recovery behavior for different values of current, temperature and dl/dt simplifies the calculations of losses in the operating conditions. The softness of the recovery eliminates the need for a snubber in most applications. These devices are ideally suited for power converters, motors drives and other applications where switching losses are significant portion of the total losses.

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	SYMBOL TEST CONDITIONS		UNITS	
Cathode to anode voltage	V <sub>R</sub>		400	V	
Continuous formand comment		T <sub>C</sub> = 25 °C	275		
Continuous forward current	١F	T <sub>C</sub> = 100 °C	138	А	
Single pulse forward current	I <sub>FSM</sub>	Limited by junction temperature	900		
Non-repetitive avalanche energy	E <sub>AS</sub>	L = 100 $\mu$ H, duty cycle limited by maximum T <sub>J</sub>	1.4	mJ	
Maximum power dissipation	PD	T <sub>C</sub> = 25 °C	463	W	
		T <sub>C</sub> = 100 °C	185	vv	
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-55 to +150	°C	

<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	V <sub>BR</sub>	I <sub>R</sub> = 100 μA		400	-	-	
		I <sub>F</sub> = 135 A		-	1.06	1.65	V
Maximum forward voltage	V <sub>FM</sub>	I <sub>F</sub> = 270 A	See fig. 1	-	1.2	2.0	
		I <sub>F</sub> = 135 A, T <sub>J</sub> = 125 °C		-	0.96	1.58	
Maximum reverse leakage current	I <sub>RM</sub>	$T_{\rm J} = 125 \ ^{\circ}\text{C}, \ V_{\rm R} = 400 \ \text{V}$	See fig. 2	-	-	3	mA
Junction capacitance	CT	V <sub>R</sub> = 200 V	See fig. 3	-	280	380	pF
Series inductance	L <sub>S</sub>	From top of terminal hole to mounting plane - 6.0 - r		nH			

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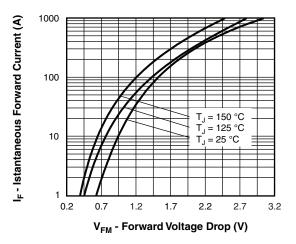


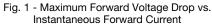
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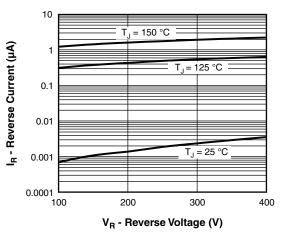
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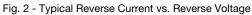
<b>DYNAMIC RECOVERY CHARACTERISTICS</b> (T <sub>J</sub> = 25 $^{\circ}$ C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CO	NDITIONS	MIN.	TYP.	MAX.	UNITS
Reverse recovery time	+	T <sub>J</sub> = 25 °C		-	77	120	200
See fig. 5	t <sub>rr</sub>	T <sub>J</sub> = 125 °C		-	280	440	ns
Peak recovery current	1	T <sub>J</sub> = 25 °C	I <sub>F</sub> = 135 A dI <sub>F</sub> /dt = 200 A/µs V <sub>R</sub> = 200 V	-	7.5	14	A
See fig. 6	IRRM	T <sub>J</sub> = 125 °C		-	15	30	
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	150	780	nC
See fig. 7		T <sub>J</sub> = 125 °C		-	2800	6300	
Peak rate of recovery current See fig. 8	di (dt	T <sub>J</sub> = 25 °C		-	350	-	A/µs
	dl <sub>(rec)M</sub> /dt	T <sub>J</sub> = 125 °C		-	300	-	λγμs

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER		SYMBOL TEST CONDITIONS		VALUES	UNITS	
Maximum junction a temperature range	ind storage	T <sub>J</sub> , T <sub>Stg</sub>		-55 to +150	°C	
Maximum thermal resistance, junction to case		R <sub>thJC</sub>	DC operation See fig. 4	0.27	20.414	
Typical thermal resistance, case to heatsink		R <sub>thCS</sub>	Mounting surface, flat, smooth and greased	0.05	°C/W	
Approximate weight				30	g	
				1.06	oz.	
Mounting torque	minimum			3 (26.5)		
Mounting torque	maximum			4 (35.4)	N·m	
Townsingstate	minimum			3.4 (30)	(lbf · in)	
Terminal torque	maximum			5 (44.2)		
Case style			HALF-PAK (D-67)			









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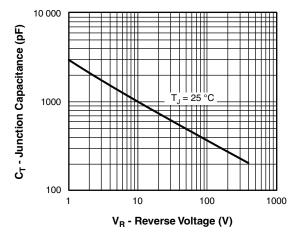


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

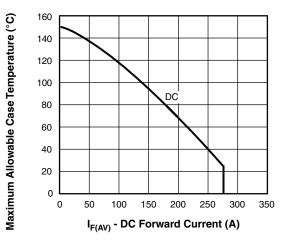


Fig. 4 - Maximum Allowable Case Temperature vs. DC Forward Current

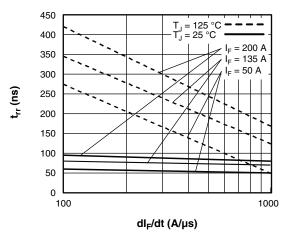
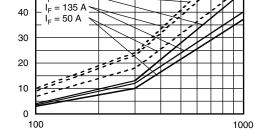


Fig. 5 - Typical Reverse Recovery Time vs. dl<sub>F</sub>/dt

70 60  $T_{J} = 125 \circ C$ 50  $I_{F} = 200 A$   $I_{F} = 135 A$  $I_{F} = 50 A$ 

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I<sub>RRM</sub> (A)

dl<sub>F</sub>/dt (A/µs)

Fig. 6 - Typical Recovery Current vs. dl<sub>F</sub>/dt

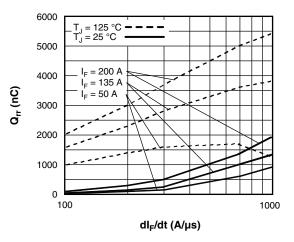
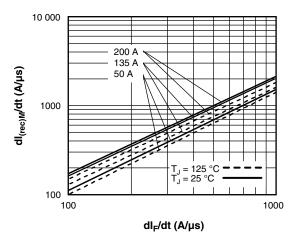


Fig. 7 - Typical Stored Charge vs. dl<sub>F</sub>/dt





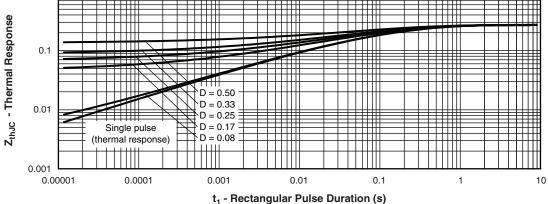
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Fig. 9 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics

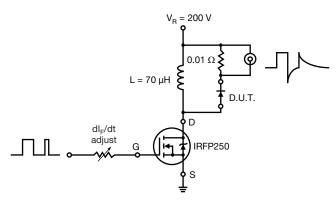
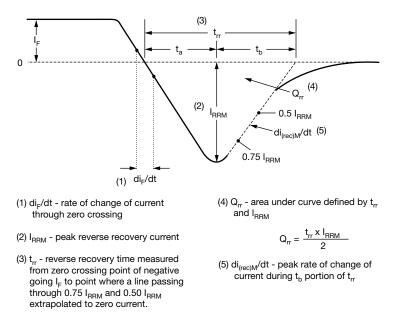
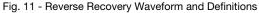


Fig. 10 - Reverse Recovery Parameter Test Circuit





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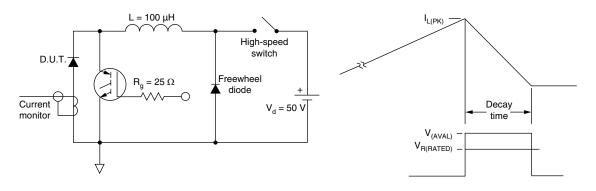
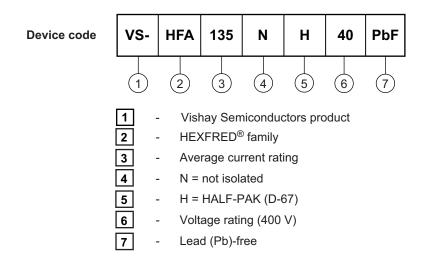


Fig. 12 - Avalanche Test Circuit and Waveforms

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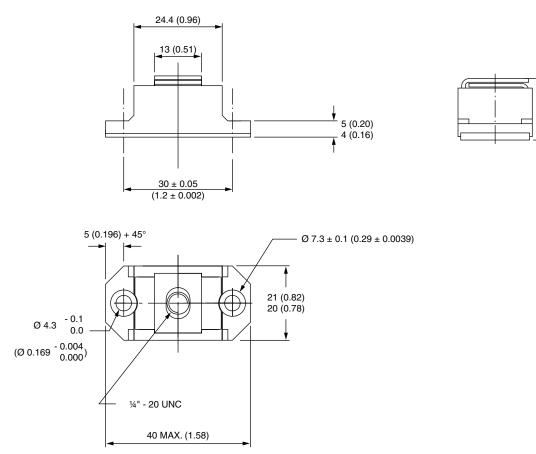
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17.5 (0.69) 16.5 (0.65)



## **DIMENSIONS** in millimeters (inches)

SHAY





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